IPC ASSOCIATION CONTELECTRONICS INDU	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both lev	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					als and Mf	g Informati	on	
upplier Inf	formation	,							,					
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi											2023-06-08			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-Env-S	Stewards	Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
Req	quester Item Number	Mfr Item	Number	Mfr Item Name]	Effective Date	Version	Manufacturing Site		V	Veight*	UOM	Unit Type
		FODM3063 4SO RP TRIA		4SO RP TRIAC			023-06-08 LITEONFG		ITEONFG	7	6.8354	mg	Each	
	ring Process Informa		Comminal Dago	Allow	STD-020 MSL R	Datina	Dools Duo	aca Dady Tam		May Time at Book	Татапапа	Myssis h	er of Reflow Cyc	laa
		·		51D-020 MSL K	canng	Peak Process Body Tempera		•				er of Reflow Cyc	ies	
	tte Tin (Sn) - annealed		CU Alloy	1			260			30	second	ls 3		
omments	4* 4 1 4 4		1	10										
	num time at peak temperat													
r more infor	rmation regarding materia	I composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	4.9	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		2.205	mg
			Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.49	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		2.205	mg
Die	2.0124	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.6538	mg
			Supplier	Silicon (Si)	7440-21-3		1.3586	mg
Die Attach	0.17	mg	Supplier	Silver (Ag)	7440-22-4		0.1326	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0374	mg
Lead Frame	20.6	mg	Supplier	Silver (Ag)	7440-22-4		0.0021	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0247	mg
			Supplier	Iron (Fe)	7439-89-6		0.4738	mg
			Supplier	Copper (Cu)	7440-50-8		20.0932	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0062	mg
Mold Compound-Black	27.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.627	mg
			Supplier	Carbon Black (C)	1333-86-4		0.279	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		2.511	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		19.53	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.953	mg
Mold Compound-White	21.1	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.22	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		14.77	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.11	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg
Wire Bond - Au	0.053	mg	Supplier	Gold (Au)	7440-57-5		0.053	mg